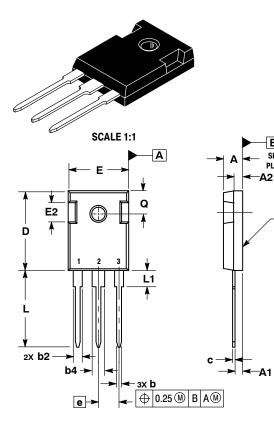
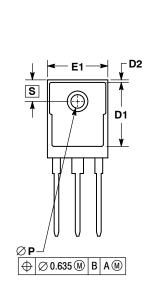
## **ISEM**Í.





TO-247 CASE 340AK ISSUE O

В

SEATING PLANE

DATE 24 APR 2013

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE: THESE DIMENSIONS ARE MEASURED AT THE CUTEDNOST EVTOEME OR THE PLASTIC RODY.

SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
4. SLOT REQUIRED, NOTCH MAY BE ROUNDED.
5. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMEN-SIONS DI AND E1.
6. LEAD FINISH UNCONTROLLED WITHIN L1.
7. ØP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.

	MILLIN	IETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.70	5.31	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	1.00	1.40	0.039	0.055
b2	1.65	2.39	0.065	0.094
b4	2.59	3.43	0.102	0.135
c	0.38	0.89	0.015	0.035
D	20.80	21.46	0.819	0.845
D1	13.08		0.515	
D2	0.51	1.35	0.020	0.053
Е	15.49	16.26	0.610	0.640
E1	13.46		0.530	
E2	4.32	5.49	0.170	0.216
e	5.46 BSC		0.215 BSC	
Г	19.81	20.32	0.780	0.800
L1		4.50		0.177
Р	3.56	3.66	0.140	0.144
Ø	5.38	6.20	0.212	0.244
s	6.15 BSC		0.242 BSC	

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